

SENSITIVE SCR

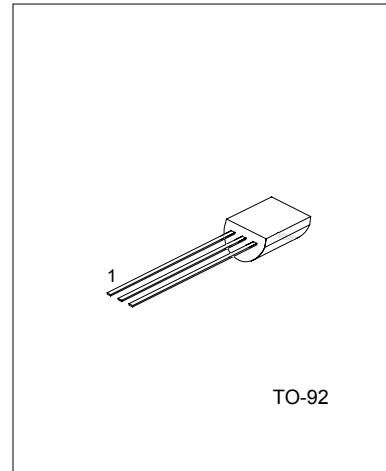
DESCRIPTION

The X0202/A SCR series is suitable for all applications where the available gate current is limited, such as ground fault circuit interruptors, overvoltage crowbar protection in low power supplies, capacitive ignition circuit,.....

FEATURES:

* $I_{T(RMS)}$: 1.25A

* V_{DRM}/V_{RRM} : 600/800V



TO-92

1:CATHODE 2:GATE 3:ANODE

ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETERS	SYMBOL	RATINGS	UNIT
Peak Repetitive Forward and Reverse Blocking Voltage ($T_j=110^\circ\text{C}$, $R_{GK}=1\text{k}\Omega$) X0202 X0202A	V_{DRM} , V_{RRM}	600 800	V
RMS On-State Current ($T_i=55^\circ\text{C}$) 180°C conduction angle	$I_{T(RMS)}$	1.25	A
Average On-State Current ($T_i=55^\circ\text{C}$) 180°C conduction angle	$I_{T(AV)}$	0.8	A
Non Repetitive Surge Peak on-state Current ($t_p=8.3\text{ms}$ $T_j=25^\circ\text{C}$)	I_{TSM}	25	A
Non Repetitive Surge Peak on-state Current ($t_p=10\text{ms}$ $T_j=25^\circ\text{C}$)	I_{TSM}	22.5	A
I_t Value for fusing ($t_p=10\text{ms}$ $T_j=25^\circ\text{C}$)	I_t	2.5	A^2s
Critical Rate Of Rise Of On-state Current $I_G=2*I_{GT,tr} \leq 100\text{ns}$, $f=60\text{Hz}$, $T_j=125^\circ\text{C}$	dI/dt	50	$\text{A}/\mu\text{s}$
Peak Gate Current ($p=20\mu\text{s}$ $T_j=125^\circ\text{C}$)	I_{GM}	1.2	A
Average Gate Power Dissipation ($T_j=125^\circ\text{C}$)	$P_{G(AV)}$	0.2	W
Storage Junction Temperature Range	T_{stg}	-40~150	$^\circ\text{C}$
Operating Junction Temperature Range	T_j	-40~125	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_j=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Peak Forward or Reverse Blocking Current $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	$I_{\text{DRM}}, I_{\text{RRM}}$	$V_{\text{DRM}}=V_{\text{RRM}}, R_{\text{GK}}=1\text{k}\Omega$			5 500	μA μA
Peak Forward On-State Voltage	V_{TM}	$I_{\text{TM}}=2.5\text{A}, t_p=380\mu\text{s}$			1.45	V
Gate Trigger Current	I_{GT}	$VD=12\text{V}, RL=140\Omega$			200	μA
Gate Trigger Voltage	V_{GT}	$VD=12\text{V}, RL=140\Omega$			0.8	V
Gate Non-Trigger Voltage	V_{GD}	$VD=V_{\text{DRM}}, RL=3.3\text{k}\Omega, R_{\text{GK}}=1\text{k}\Omega, (T_j=125^\circ\text{C})$	0.1			V
Holding Current	I_{H}	$I_{\text{H}}=50\text{mA}, R_{\text{GK}}=1\text{k}\Omega$			5	mA
Latch Current	I_{L}	$I_{\text{L}}=1\text{mA}, R_{\text{GK}}=1\text{k}\Omega$			6	mA
Critical Rate of Rise of Off-State Voltage	dv/dt	$VD=67\%V_{\text{DRM}}, R_{\text{GK}}=1\text{k}\Omega, (T_j=110^\circ\text{C})$	10			V/ μs
Peak Reversed Gate Voltage	V_{RG}	$I_{\text{RG}}=10\mu\text{A}$	8			V
Threshold Voltage	V_{TO}	$(T_j=125^\circ\text{C})$			0.9	V
Dynamic Resistance	R_d	$(T_j=125^\circ\text{C})$			200	$\text{m}\Omega$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{\text{th(j-l)}}$	Junction to leads	60	$^\circ\text{C/W}$
$R_{\text{th(j-a)}}$	Junction to ambient	150	$^\circ\text{C/W}$

TYPICAL CHARACTERISTICS CURVE

Figure 1. Maximum Average Power Dissipation vs. Average On-stage Current

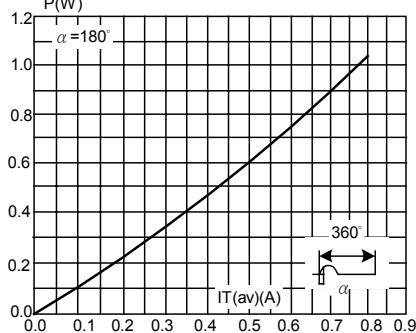


Figure 2-1. Average and D.C. On-state Current vs. Lead Temperature

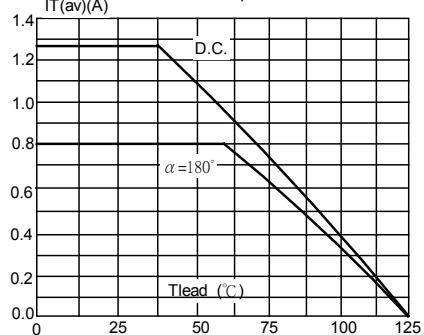


Figure 2-2-Average and D.C. On-state Current vs.Ambient Temperature(Device Mounted On FR4 with Recommended Pad Layout)

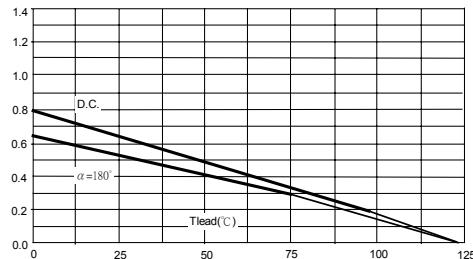


Figure 4.Relative Variation of Gate Trigger Current,Holding Current and Latching Current Versus Junction Temperature (typical values).
IGT,IH,IL[T]/GT,IH,IL[T]=25°C

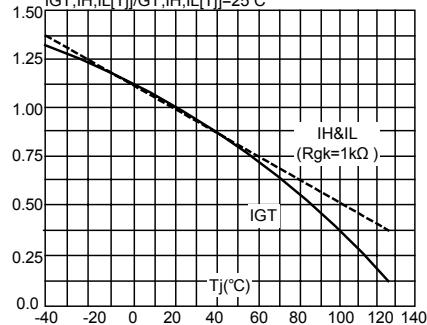


Figure 6.Relative Variation of dV/dt immunity vs.Gate-Cathode Resistance (typical values).
dV/dt[Rgk]/dV/dt[Rgk=1kΩ]

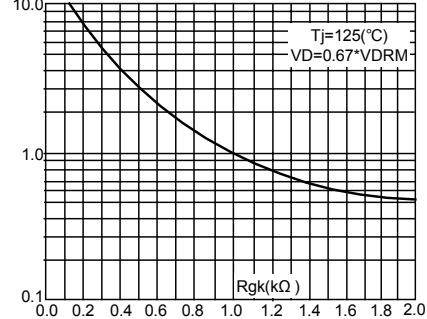


Figure 3.Relative Variation of Thermal Impedance Junction to Ambient vs.Pulse Duration

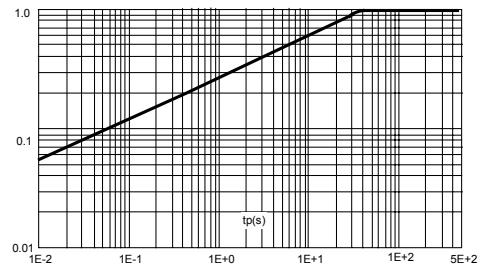


Figure 5.Relative Variation of Holding Current vs.Gate-cathode Resistance (typical values).

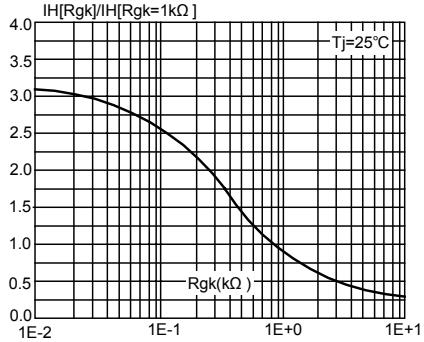
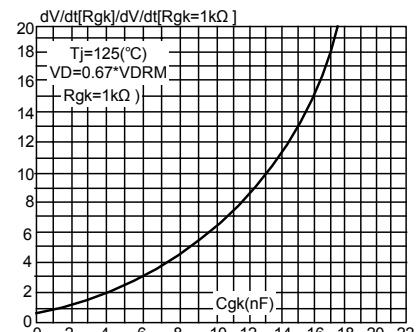
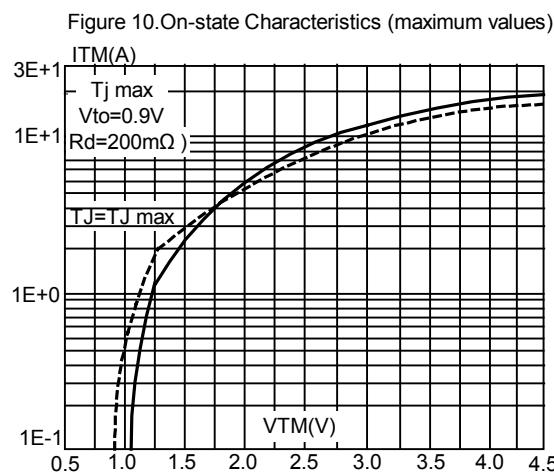
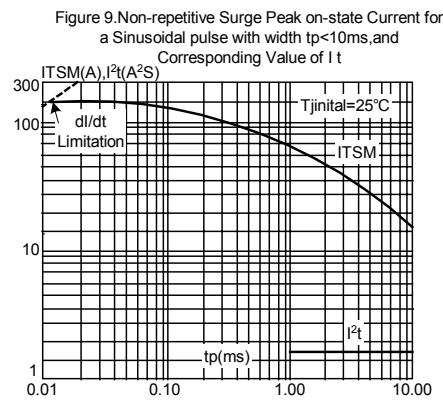
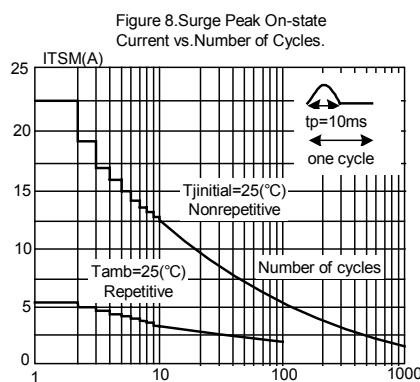


Figure 7.Relative Variation of dV/dt Immunity vs Gate-cathode Capacitance (typical values).





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